

Product Change Notification - LIAL-12ESQP749

Date:

04 Oct 2019 **Product Category:** Simple and Complex Programmable Logic

Affected CPNs:

1

Notification subject:

CCB 3838 Final Notice: Qualification of MMT as a new assembly site for selected Atmel product of the 19.7k wafer technology available in 28L CLCC (11.4x11.5x2.54mm) package

Notification text:

PCN Status: Final notification.

PCN Type: Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:

Qualification of MMT as a new assembly site for selected Atmel product of the 19.7k wafer technology available in 28L CLCC (11.4x11.5x2.54mm) package.

Pre Change:

Assembled at ANAP

Post Change:

Assembled at MMT

Pre and Post Change Summary:

	Pre Change	Post Change			
		Microchip Technology			
	Amkor Technology	Thailand			
Assembly Site	Philippine (P1/P2), INC.				
	(ANAP)	(Branch)			
		(MMT)			
Wire material	AI	AI			
Die attach material	QMI3555	QMI3555			
Lead frame material	Alloy 42	Alloy 42			

Impacts to Data Sheet: None

Change Impact: None



Reason for Change:

To improve on-time delivery performance by qualifying MMT as a new assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

November 4, 2019 (date code: 1945)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	October 2019				November 2019				
Workweek	40	41	42	43	44	45	46	47	48
Final PCN Issue Date	Х								
Qual Report Availability	Х								
Estimated Implementation Date						Х			

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

October 4, 2019: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on November 4, 2019.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_LIAL-12ESQP749__QUAL REPORT SUMMARY.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

ATF22V10B-10NM/883 ATF22V10B-15NM/883 ATF22V10C-10NM/883 ATF22V10C-15NM/883 ATF750C-10NM/883 ATF750C-15NM/883